

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS

General purpose Class 1, NPO

16 V TO 50 V 0.22 pF to 100 nF

RoHS compliant & Halogen Free



YAGEO Phícomp



SCOPE

This specification describes NP0 series chip capacitors with lead-free terminations.

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APPLICATIONS

- Consumer electronics for example
 - Tuners
 - Television receivers
 - All types of cameras
- Telecommunications
- Data processing

FEATURES

- Supplied in tape on reel
- Nickel-barrier end termination
- RoHS compliant
- Halogen Free compliant

ORDERING INFORMATION-GLOBAL PART NUMBER, PHYCOMP

CTC & 12NC

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

CC <u>xxxx</u> <u>x</u> <u>x</u> <u>NPO <u>x</u> BN <u>xxx</u> (5)</u>

(I) SIZE - INCH BASED (METRIC)

0201 (0603)

0402 (1005)

0603 (1608)

0805 (2012)

1206 (3216)

1210 (3225)

1812 (4532)

(2) TOLERANCE

 $B = \pm 0.1 pF$

 $C = \pm 0.25 \text{ pF}$

 $D = \pm 0.5 pF$

 $F = \pm 1\%$

 $G = \pm 2\%$

 $J = \pm 5\%$

 $K = \pm 10\%$

(3) PACKING STYLE

R = Paper/PE taping reel; Reel 7 inch

K = Blister taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

F = Blister taping reel; Reel 13 inch

C = Bulk case

(4) RATED VOLTAGE

7 = 16 V

8 = 25 V

9 = 50 V

(5) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

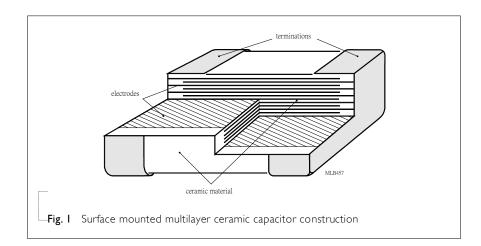
Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$



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The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Eig I

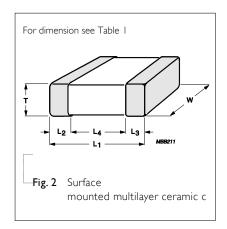


DIMENSION

Table I For outlines see fig. 2

TYPE	L _I (mm)	W (mm)	T (MM)	L ₂ / L ₃ min.	max.	L ₄ (mm) min.
0201	0.6 ±0.03	0.3 ±0.03	_	0.10	0.20	0.20
0402	1.0 ±0.05	0.5 ±0.05	_	0.20	0.30	0.40
0603	1.6 ±0.10	0.8 ±0.10	_	0.20	0.60	0.40
0805	2.0 ±0.10 ⁽¹⁾	1.25 ±0.10 ⁽¹⁾		0.25	0.75	٥٢٢
	2.0 ±0.20 ⁽²⁾	1.25 ±0.20 ⁽²⁾	Refer to - table 2 to 5	0.25	0.75	0.55
1206	3.2 ±0.15 ⁽¹⁾	1.6 ±0.15 ⁽¹⁾	table 2 to 3	0.25	0.75	1.40
1200	3.2 ±0.30 ⁽²⁾	1.6 ±0.20 ⁽²⁾	<u></u>	0.25	0.75	1.40
1210	3.2 ±0.20	2.5 ±0.20	_	0.25	0.75	1.40
1812	4.5 ±0.20	3.2 ±0.20		0.25	0.75	2.20

OUTLINES



NOTE

- 1. Dimension for size 0805 and 1206, C ≤ I nF
- 2. Dimension for size 0805 and 1206, C > I nF

14

Surface-Mount Ceramic Multilayer Capacitors General Purpose NPO

16 V to 50 V

CAPACITANCE RANGE & THICKNESS FOR NPO

Table 2	Sizes fro	om 0201	to 0	603

CAP.	0201		0402			0603		
	25 V	50 V	16 V	25 V	50 V	16 V	25 V	50 V
0.22 pF								
0.47 pF								
0.82 pF								
1.0 pF								
1.2 pF								
1.5 pF								
1.8 pF								
2.2 pF								
2.7 pF								
3.3 pF								
3.9 pF								
4.7 pF								
5.6 pF								
6.8 pF	0.3±0.03	0.3±0.03						
8.2 pF	0.5±0.05	0.5±0.05	0.5±0.05	0.5±0.05	0.5±0.05	0.8±0.1	0.8±0.1	0.8±0.1
10 pF								
12 pF								
15 pF								
18 pF								
22 pF								
27 pF								
33 pF								
39 pF								
47 pF								
56 pF								
68 pF								
82 pF								
100 pF								

NOTE



NP0

16 V to 50 V

CAPACITANCE RANGE & THICKNESS FOR NPO

Table 3	Sizes from	0201 to	0603	(continued)	

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CAP.	0201	(0402			0603		
	25 V	50 V	16 V	25 V	50 V	16 V	25 V	50 V
120 pF								
150 pF								
180 pF								
220 pF								
270 pF			0.5±0.05	0.5±0.05	0.5±0.05			
330 pF								
390 pF								
470 pF								
560 pF						0.0101	00101	00101
680 pF						0.8±0.1	0.8±0.1	0.8±0.1
820 pF		_						
I.O nF			0.5±0.05	0.5±0.05	0.5±0.05			
I.2 nF								
1.5 nF								
I.8 nF								
2.2 nF								
2.7 nF								
3.3 nF								
3.9 nF								
4.7 nF								
5.6 nF								
6.8 nF								
8.2 nF								
I0 nF								
I2 nF								
15 nF								
18 nF								
22 nF								
33 nF								

NOTE



14

NP0 16 V to 50 V

CAPACITANCE RANGE & THICKNESS FOR NPO

Surface-Mount Ceramic Multilayer Capacitors General Purpose

		=	
Table 4	Sizes from	()8()5 to	1812

CAP.	0805	.5 (5 .5.2		1206			1210		1812
	16 V	25 V	50 V	16 V	25 V	50 V	25 V	50 V	50 V
0.22 pF									
0.47 pF									
0.82 pF									
1.0 pF									
1.2 pF									
1.5 pF									
1.8 pF									
2.2 pF									
2.7 pF									
3.3 pF									
3.9 pF									
4.7 pF									
5.6 pF									
6.8 pF									
8.2 pF	0.6±0.1	0.6±0.1	0.6±0.1	0.6±0.1	0.6±0.1	0.6±0.1			
10 pF									
12 pF									
15 pF									
18 pF									
22 pF									
27 pF									
33 pF									
39 pF									
47 pF									
56 pF									
68 pF							1.25±0.2	1.25±0.2	1.25±0.2
82 pF									1,23±0,2
100 pF									

NOTE

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16 V to 50 V

CAPACITANCE RANGE & THICKNESS FOR NPO

Table 5	Sizes from	0805 to	1812	(continued)

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CAP.	zes from 0805 0805	0 (0.	3.16.1.10.00)	1206			1210		1812
	16 V	25 V	50 V	16 V	25 V	50 V	25 V	50 V	50 V
120 pF									
150 pF									
180 pF									
220 pF									
270 pF									
330 pF	07101	0 (1 0 1	0 (10 1						
390 pF	0.6±0.1	0.6±0.1	0.6±0.1						
470 pF									
560 pF				0.6±0.1	0.6±0.1	0.6±0.1			
680 pF									
820 pF									
1.0 nF							125.02	125.02	
1.2 nF							1.25±0.2	1.25±0.2	
1.5 nF	0.85±0.1	0.85±0.1	0.85±0.1						1.25.10.2
1.8 nF									1.25±0.2
2.2 nF									
2.7 nF			_						
3.3 nF									
3.9 nF	1.25±0.2	1.25±0.2	1.25±0.2						
4.7 nF				0.85±0.1	0.85±0.1	0.85±0.1			
5.6 nF									
6.8 nF									
8.2 nF									
I0 nF	0.85±0.1	0.85±0.1	0.85±0.1						
I2 nF				125102	1.25±0.2	125102			
15 nF				1.25±0.2	1.25±0.2	1.25±0.2			
18 nF									
22 nF							2.0±0.2		
33 nF									
47 nF									
56 nF									
68 nF									
82 nF									
100 nF						1.25±0.2			

NOTE



16 V to 50 V

THICKNESS CLASSES AND PACKING QUANTITY

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	ь		Ø180 MM	/7INCH	Ø330 MM	/ 13 INCH	
SIZE CODE	THICKNESS CLASSIFICATION	TAPE WIDTH — QUANTITY PER REEL	Paper	Blister	Paper	Blister	QUANTITY PER BULK CASE
0201	0.3 ±0.03 mm	8 mm	15,000		50,000		
0402	0.5 ±0.05 mm	8 mm	10,000		50,000		50,000
0603	0.8 ±0.1 mm	8 mm	4,000		15,000		15,000
	0.6 ±0.1 mm	8 mm	4,000		20,000		10,000
0805	0.85 ±0.1 mm	8 mm	4,000		15,000		8,000
	1.25 ±0.2 mm	8 mm		3,000		10,000	5,000
	0.6 ±0.1 mm	8 mm	4,000		20,000		
	0.85 ±0.1 mm	8 mm	4,000		15,000		
1206	1.00 / 1.15 ±0.1 mm	8 mm		3,000		10,000	
1206	1.25 ±0.2 mm	8 mm		3,000		10,000	
	1.6 ±0.15 mm	8 mm		2,500		10,000	
	1.6 ±0.2 mm	8 mm		2,000		10,000	
	0.6 / 0.7 ±0.1 mm	8 mm		4,000		15,000	
	0.85 ±0.1 mm	8 mm		4,000		10,000	
	1.0 ±0.1 mm	8 mm		3,000		10,000	
1210	1.15 ±0.1 mm	8 mm		3,000		10,000	
	1.15 ±0.15 mm	8 mm		3,000		10,000	
	1.25 ±0.2 mm	8 mm		3,000			
	1.5 ±0.1 mm	8 mm		2,000			
	1.6 / 1.9 ±0.2 mm	8 mm		2,000			
	2.0 ±0.2 mm	8 mm		2,000 1,000			
	2.5 ±0.2 mm	8 mm		1,000 500			
	1.15 ±0.15 mm	I2 mm		3,000			
	1.25 ±0.2 mm	I2 mm		3,000			
1808	1.35 ±0.15 mm	I2 mm		2,000			
1000	1.5 ±0.1 mm	I2 mm		2,000			
	1.6 ±0.2 mm	12 mm		2,000			
	2.0 ±0.2 mm	I2 mm		2,000			
	0.6 / 0.85 ±0.1 mm	I2 mm		2,000			
	1.15 ±0.1 mm	I2 mm		1,000			
	1.15 ±0.15 mm	I2 mm		1,000			
1012	1.35 ±0.15 mm	I2 mm		1,000			
1812	1.5 ±0.1 mm	I2 mm		1,000			
	1.6 ±0.2 mm	I2 mm		1,000			
	2.0 ±0.2 mm	I2 mm		1,000			
	2.5 ±0.2 mm	I2 mm		500			



ELECTRICAL CHARACTERISTICS

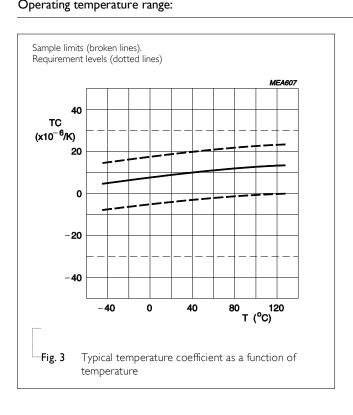
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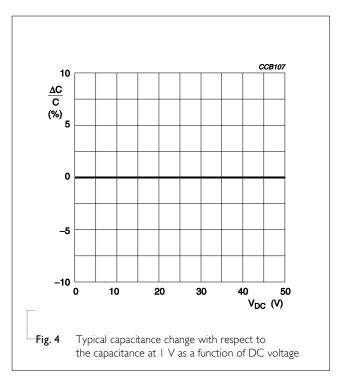
NP0 DIELECTRIC CAPACITORS; NISN TERMINATIONS

Unless otherwise stated all electrical values apply at an ambient temperature of 20±1 °C, an atmospheric pressure of 86 to 106 kPa, and a relative humidity of 63 to 67%.

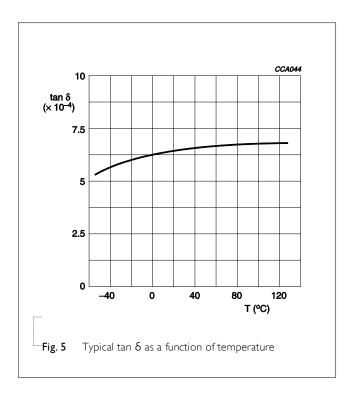
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DESCRIPTION		VALUE
Capacitance range		0.22 pF to 100 nF
Capacitance tolerance		
	C < 10 pF	±0.1 pF, ±0.25 pF, ±0.5 pF
	C ≥ 10 pF	±1%, ±2%, ±5%, ±10%
Dissipation factor (D.F	.)	
	C < 30 pF	≤ I / (400 + 20C)
	C ≥ 30 pF	≤ 0.1 %
Insulation resistance after 1 minute at U _r (DC)		$R_{ins} \ge 10 \text{ G}\Omega$ or $R_{ins} \times C_r \ge 500$ seconds whichever is less
Maximum capacitance	change as a function of temperature	
(temperature characteristic/coefficient):		±30 ppm/°C
Operating temperature range:		_55 °C to +125 °C









SOLDERING RECOMMENDATION

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Table 8

SOLDERING METHOD	SIZE 0201	0402	0603	0805	1206	≥ 1210
Reflow	Reflow only	≥ 0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave		< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	



TESTS AND REQUIREMENTS

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TEST	TEST MET	ocedures and requirements ST METHOD PROCEDURE		REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual inspection and dimensio n check		4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance		4.5.1	Class I: $f = I \text{ MHz for C} \le I \text{ nF, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$ $f = I \text{ KHz for C} > I \text{ nF, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$	Within specified tolerance
Dissipation factor (D.F.)		4.5.2	Class I: $f = I \text{ MHz for C} \le I \text{ nF} \text{ , measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$ $f = I \text{ KHz for C} > I \text{ nF, measuring at voltage } I \text{ V}_{rms} \text{ at } 20 \text{ °C}$	In accordance with specification
Insulation		4.5.3	At U _r (DC) for I minute	In accordance with specification
Temperature coefficient		4.6	Capacitance shall be measured by the steps shown in the following table. The capacitance change should be measured after 5 min at each specified temperature stage. Step Temperature(°C) a 25±2 b Lower temperature±3°C c 25±2 d Upper Temperature±2°C e 25±2 (I) Class I Temperature Coefficient shall be calculated from the formula as below Temp, Coefficient = $\frac{C2 - C1}{C1 \times \Delta T} \times 10^6$ [ppm/°C] C1: Capacitance at step c C2: Capacitance at 125°C ΔT : 100 °C(=125°C-25°C) (2) Class II Capacitance Change shall be calculated from the formula as below $\Delta C = \frac{C2 - C1}{C1} \times 100\%$ C1: Capacitance at step c	<general purpose="" series=""> Class I: Δ C/C: ±30ppm Class 2: X7R: Δ C/C: ±15% Y5V: Δ C/C: 22~-82% <high capacitance="" series=""> Class 2: X7R/X5R: Δ C/C: ±15% Y5V: Δ C/C: 22~-82%</high></general>

C2: Capacitance at step b or d

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16 V to 50 V

TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Adhesion		4.7	A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate	Force size ≥ 0603: 5N size = 0402: 2.5N size = 0201: 1N
Bond strengt h of plating		4.8	Mounting in accordance with IEC 60384-22 paragraph 4.3	No visible damage
on end face			Conditions: bending I mm at a rate of I mm/s, radius jig 340 mm	<pre><general purpose="" series=""> ΔC/C Class 1: NP0: within ±1% or 0.5 pF whichever is greater</general></pre>
Resistance to soldering heat	IEC 60384- 21/22	4.9	Precondition: 150 +0/−10 °C for I hour, then keep for 24 ±1 hours at room temperature Preheating: for size ≤ 1206: 120 °C to 150 °C for I minute Preheating: for size > 1206: 100 °C to 120 °C for I minute	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned
			and 170 °C to 200 °C for I minute	<general purpose="" series=""></general>
			Solder bath temperature: 260 ±5 °C	ΔC/C
			Dipping time: 10 \pm 0.5 seconds Recovery time: 24 \pm 2 hours	Class 1: NPO: within ±0.5% or 0.5 pF whichever is greater
				D.F. within initial specified value R _{ins} within initial specified value
Solderability		4.10	Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The solder should cover over 95% of the critical area of each termination
			 Temperature: 235±5°C / Dipping time: 2 ±0.5 s Temperature: 245±5°C / Dipping time: 3 ±0.5 s (lead free)Depth of immersion: 10mm 	
Rapid change of		4.11	Preconditioning 150 +0/–10 °C for 1 hour, then keep for	No visual damage
temperature			24 ±1 hours at room temperature	<general purpose="" series=""></general>
			5 cycles with following detail:	ΔC/C
			30 minutes at lower category temperature	Class I:
			30 minutes at upper category temperature	NP0: within ±1% or 1 pF whichever is greater
			Recovery time 24 ±2 hours	5.0.0. 8 8. 04.01
				D.F. meet initial specified value R _{ins} meet initial specified value



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16 V to 50 V

TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Damp heat with U _r load	IEC 60384- 21/22	4.13	1. Preconditioning, class 2 only: I 50 +0/-10 °C /I hour, then keep for	No visual damage after recovery	
			24 ±1 hour at room temp	<general purpose="" series=""></general>	
			2. Initial measure:	ΔC/C	
			Spec: refer to initial spec C, D, IR	Class I:	
			3. Damp heat test:	NP0: within $\pm 2\%$ or 1 pF	
			500 \pm 12 hours at 40 \pm 2 °C;	whichever is greater	
			90 to 95% R.H. I.0 U _r applied	D.F.	
			4. Recovery:	Class I:	
			Class 1: 6 to 24 hours	NP0: $\leq 2 \times \text{specified value}$	
			5. Final measure: C, D, IR	R _{ins}	
				Class I:	
			P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to	NP0: \geq 2,500 M Ω or $R_{ins} \times C_r \geq$ 25s whichever is less	
			"IEC 60384 4.1" and then the requirement shall be met.		
Endurance		4.14	1. Preconditioning, class 2 only: 150 +0/-10 °C /I hour, then keep for	No visual damage	
			24 ±1 hour at room temp 2. Initial measure:	<general purpose="" series=""></general>	
				ΔC/C	
			Spec: refer to initial spec C, D, IR	Class I:	
			3. Endurance test:	NP0: within ±2% or 1 pF	
			Temperature: NP0: 125 °C	whichever is greater	
			Specified stress voltage applied for 1,000 hours:	D.F.	
			Applied 2.0 x U _r for general product.	Class I:	
			4. Recovery time: 24 ±2 hours	NP0: $\leq 2 \times \text{specified value}$	
			5. Final measure: C, D, IR	R _{ins}	
				Class I:	
			P.S. If the capacitance value is less than the minimum value		
			permitted, then after the other measurements have been	NP0: \geq 4,000 M Ω or $R_{ins} \times C_r \geq$ 40s whichever is less	
			made the capacitor shall be preconditioned according to	Willeriever is less	
			"IEC 60384 4.1" and then the requirement shall be met.		
V-16	150 (0304)	4.4			
Voltage proof	IEC 60384-1	4.6	Specified stress voltage applied for 1 minute $U_r \le 100 \text{ V}$: series applied 2.5 U_r $100 \text{ V} < U_r \le 200 \text{ V}$ series applied (1.5 $U_r + 100$) $200 \text{ V} < U_r \le 500 \text{ V}$ series applied (1.3 $U_r + 100$) $U_r > 500 \text{ V}$: 1.3 U_r I: 7.5 mA	No breakdown or flashover	



16 V to 50 V

14

REVISION HISTORY

YAGEO Phicomp

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 10	Feb. 18, 2014		- Product range updated
Version 9	Jun. 17, 2013		- Product range updated
Version 8	Aug 05, 2011		- Dimension updated
Version 7	Jun 14, 2011	-	- Size1210 T=1.0mm SPQ added - Dimension updated
Version 6	Jan 06, 2011	-	- Dimension updated
Version 5	Dec 29, 2010	-	- Dimension updated
Version 4	Nov 23, 2010	-	- Dimension updated
Version 3	Apr 20, 2010	-	- The statement of "Halogen Free" on the cover added - Dimension updated
Version 2	Oct 26, 2009	-	- Typo updated
Version I	Jun 02, 2009	-	- I2NC code updated
Version 0	Apr 15, 2009	-	- New datasheet for general purpose NP0 series with RoHS compliant
			- Replace the "16V to 50V" part of pdf files: NP0_16V_7, NP0_16V-to-100V_6, NP0_25V_7, NP0_50-to-500V_11
			- Combine 020 I from pdf files: UP-NP0X5RX7RY5V_020 I_6.3-to-50V_2 and UY-NP0X5RX7RY5V_020 I_6.3-to-50V_2
			- Define global part number
			- Description of "Halogen Free compliant" added
			- Test method and procedure updated

